

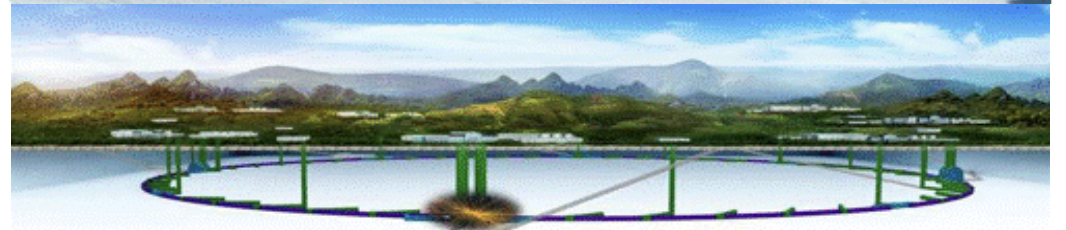
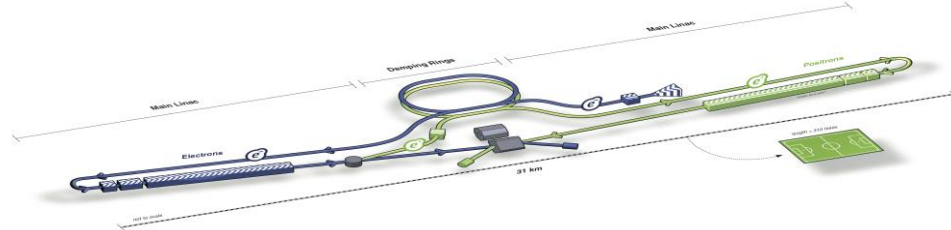
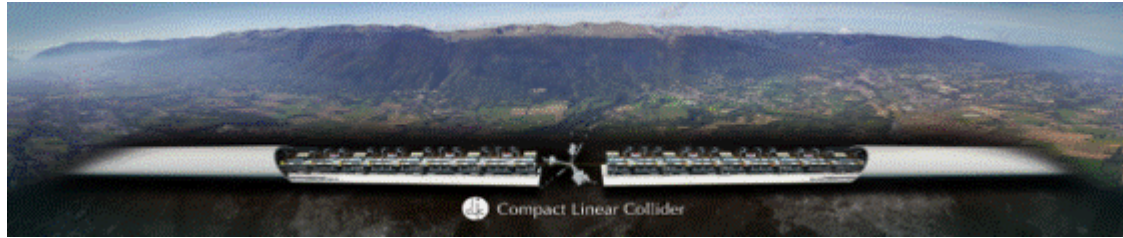
# **A new scheme for Micromegas TPC readout : the encapsulated resistive anode with reverse grounding**

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# Introduction : tracking at e+e- colliders

The next High Energy collider will be an e+e- for Higgs precision studies



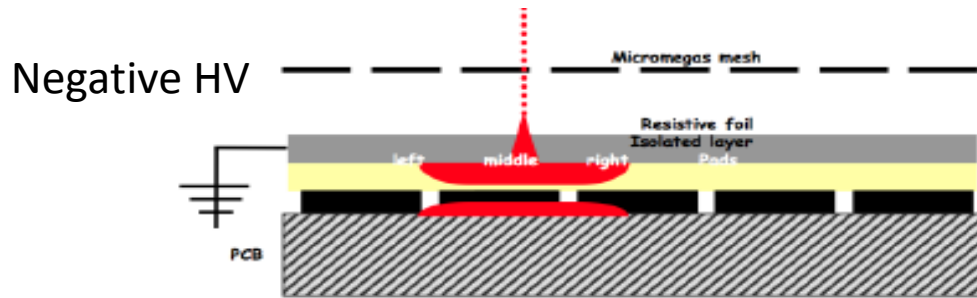
	LINEAR	CIRCULAR
EUROPE	CLIC	FCC-ee
ASIA	ILC	CEPC
	New technology + : polarization possible  Upgradable in energy	Standard technology + : high luminosity  Limited in energy Large tunnel Perspective : hh

ILC environment is best suited for a TPC as main tracker.

Adaptation would be needed for other machines

# Charge spreading by resistive-capacitive anode

Standard scheme



The RC continuous circuit evenly spreads the charge, allowing sharing between neighbouring pads

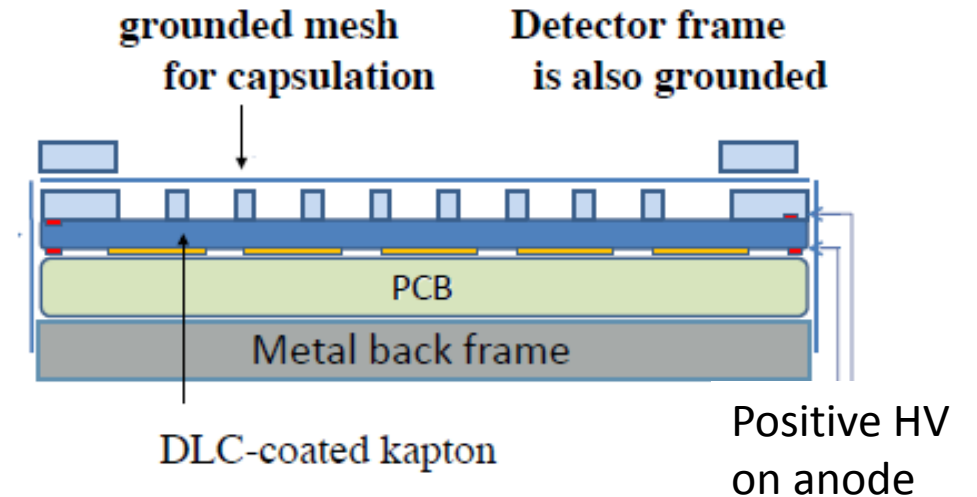
$$\rho(r, t) = \frac{RC}{2t} \exp\left[-\frac{r^2 RC}{4t}\right]$$

R- surface resistivity

C- capacitance/unit area

M. Dixit et al.

New scheme



New scheme, to **reduce distortions** at the edges of the modules : mesh

at the same potential as the frame, and resistive anode at the +ve HV. Also encapsulation **reduces the EMI**.

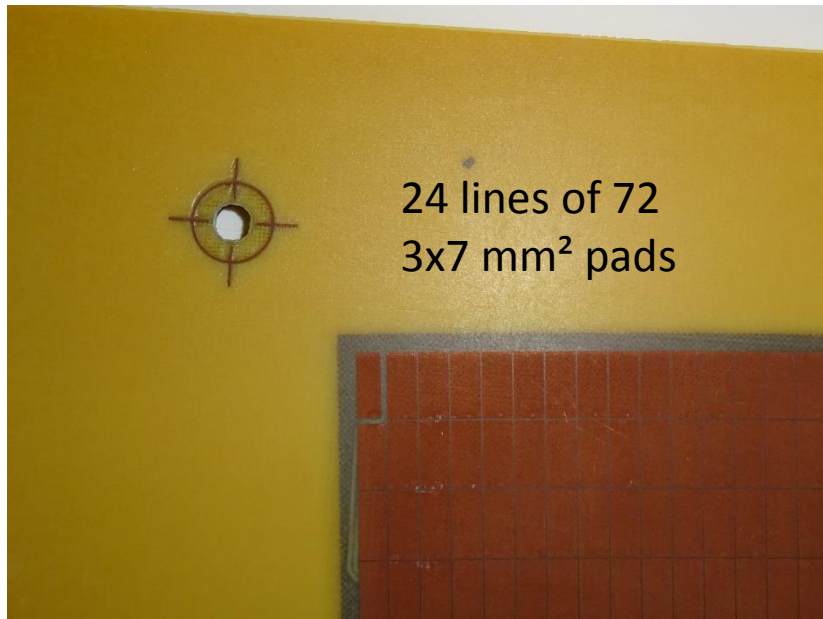
Another advantage: the amplification field can be tuned independently of the drift field, providing **flexibility**.

The gains can be equalized while keeping the drift field very uniform.

# Beam tests

This new scheme was applied in 2018 to

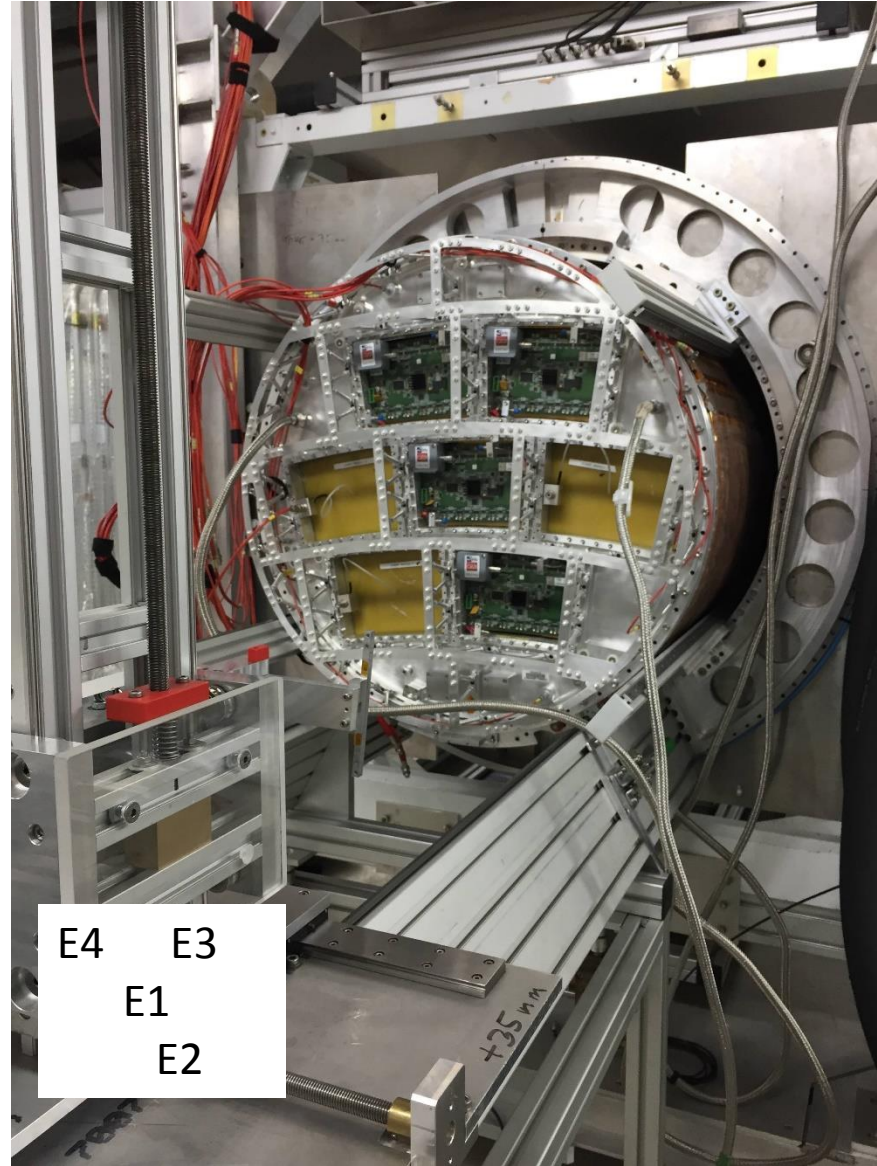
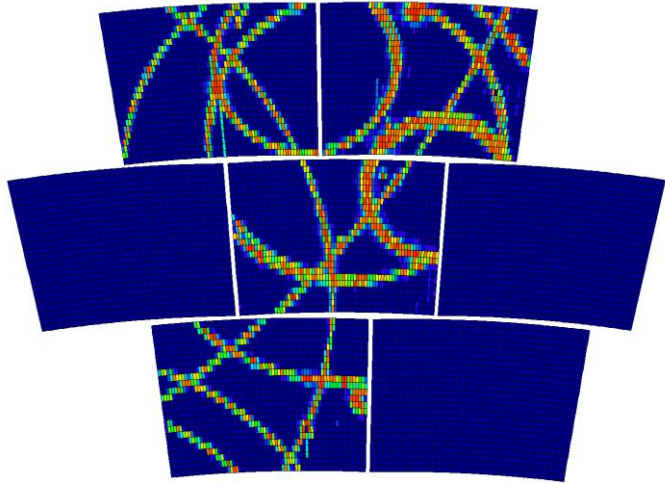
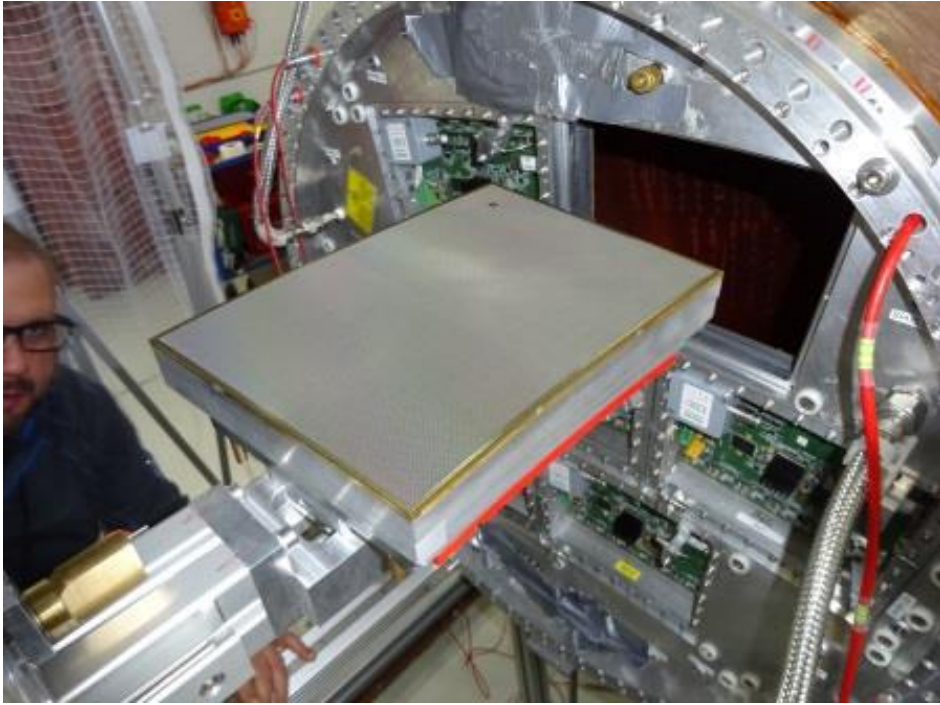
- T2K (D. Attié, previous talk, and A. Delbart, VCI) and to
- ILC-TPC (this talk) : beam tests at DESY, November 2018



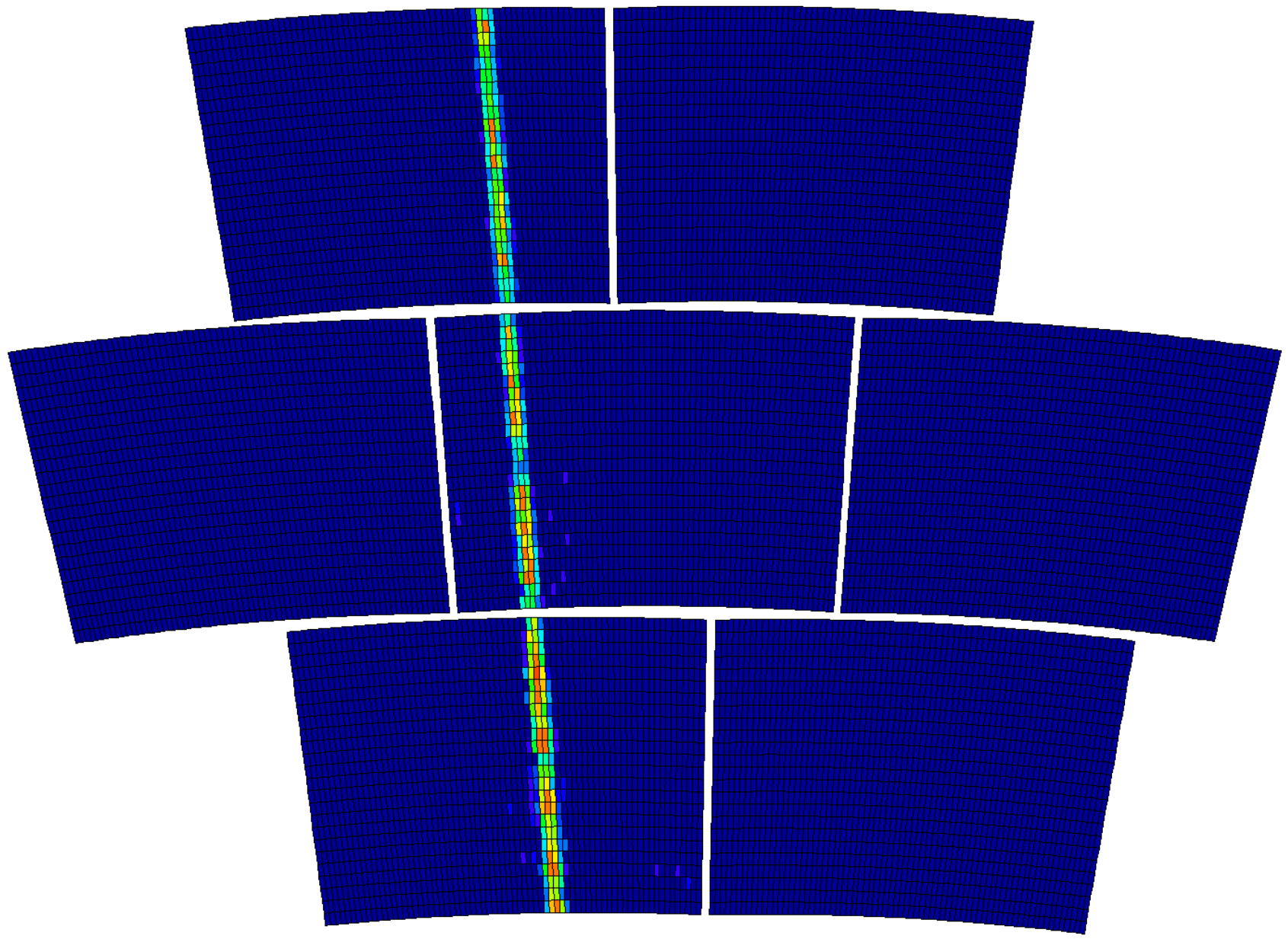
First resistive bulk for T2K/ND280

Pad PCB covered with 70  $\mu\text{m}$  insulator + DLC on kapton.

The DLC foils (2.5 Mohm/sq) were not very good (runnings), except one  
New modules are numbered E1, E2, E3, E4 in decreasing quality order

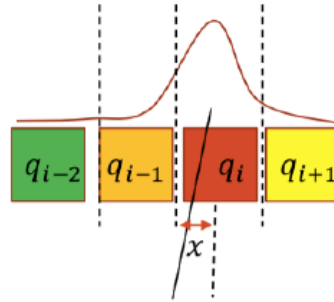


E4 E3  
E1  
E2



# Pad Response function

2D distribution :  
Charge fraction vs Xpad-Xtrack

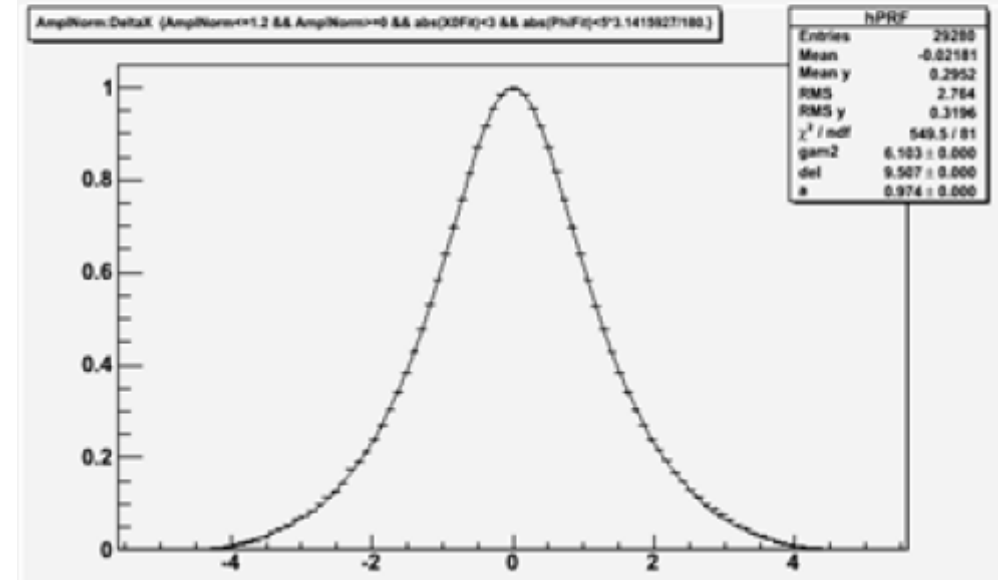
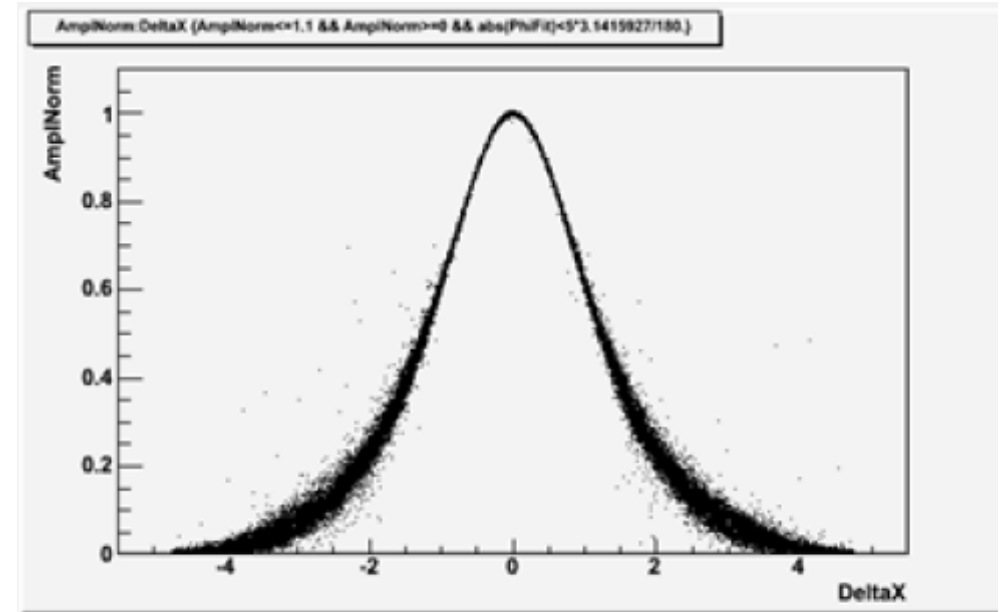


Fit a parameterization to the profile, for i

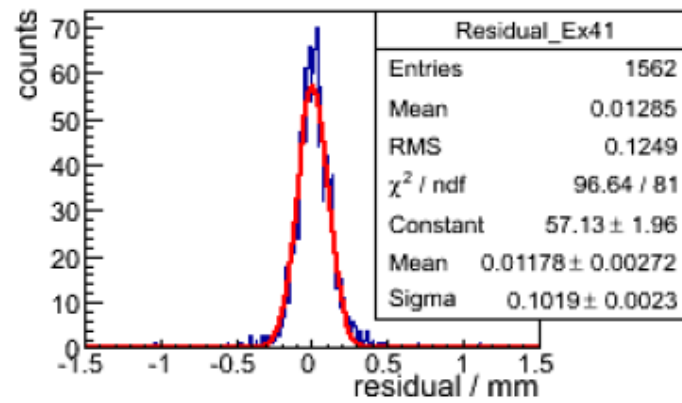
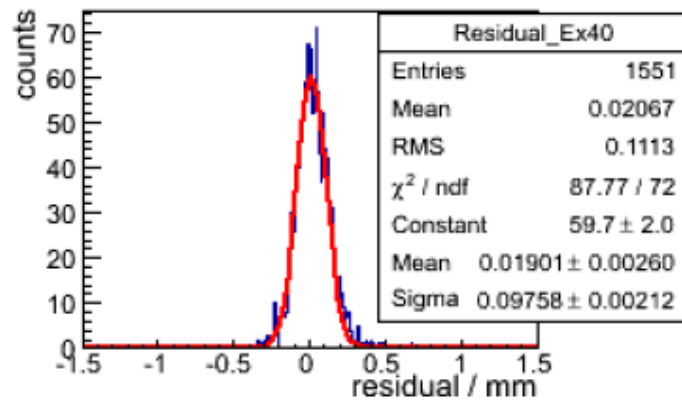
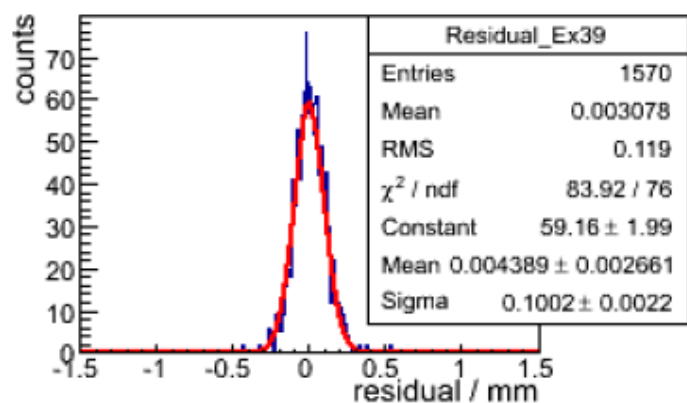
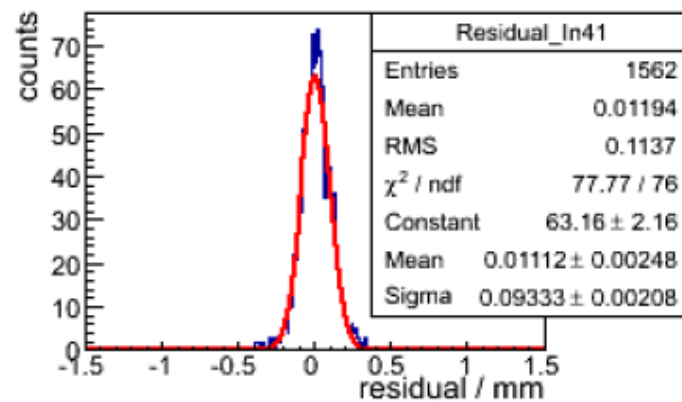
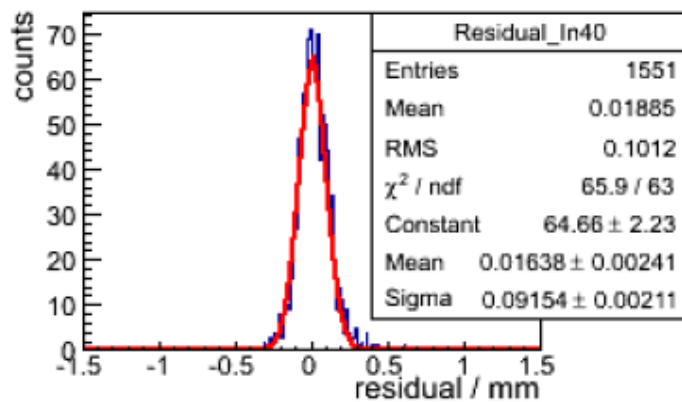
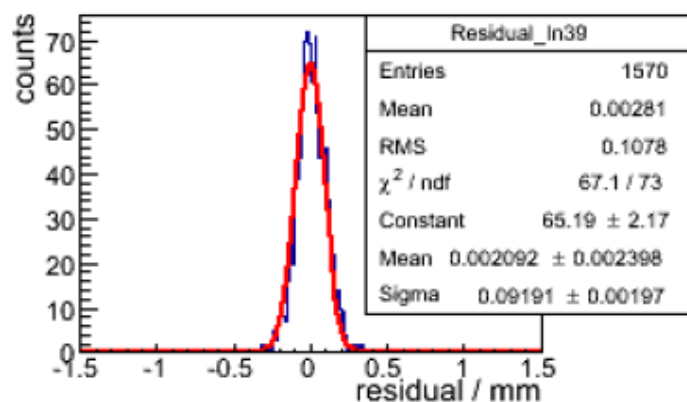
$$PRF(x, r, w) = \frac{\exp[-4 \ln 2 (1-r) x^2 / w^2]}{1 + 4r x^2 / w^2}$$

Use the Pad Response Function to obtain the track position in each padrow from the charge fraction

Re-fit the track and iterate



# Residuals of the fitted track (after iterations)

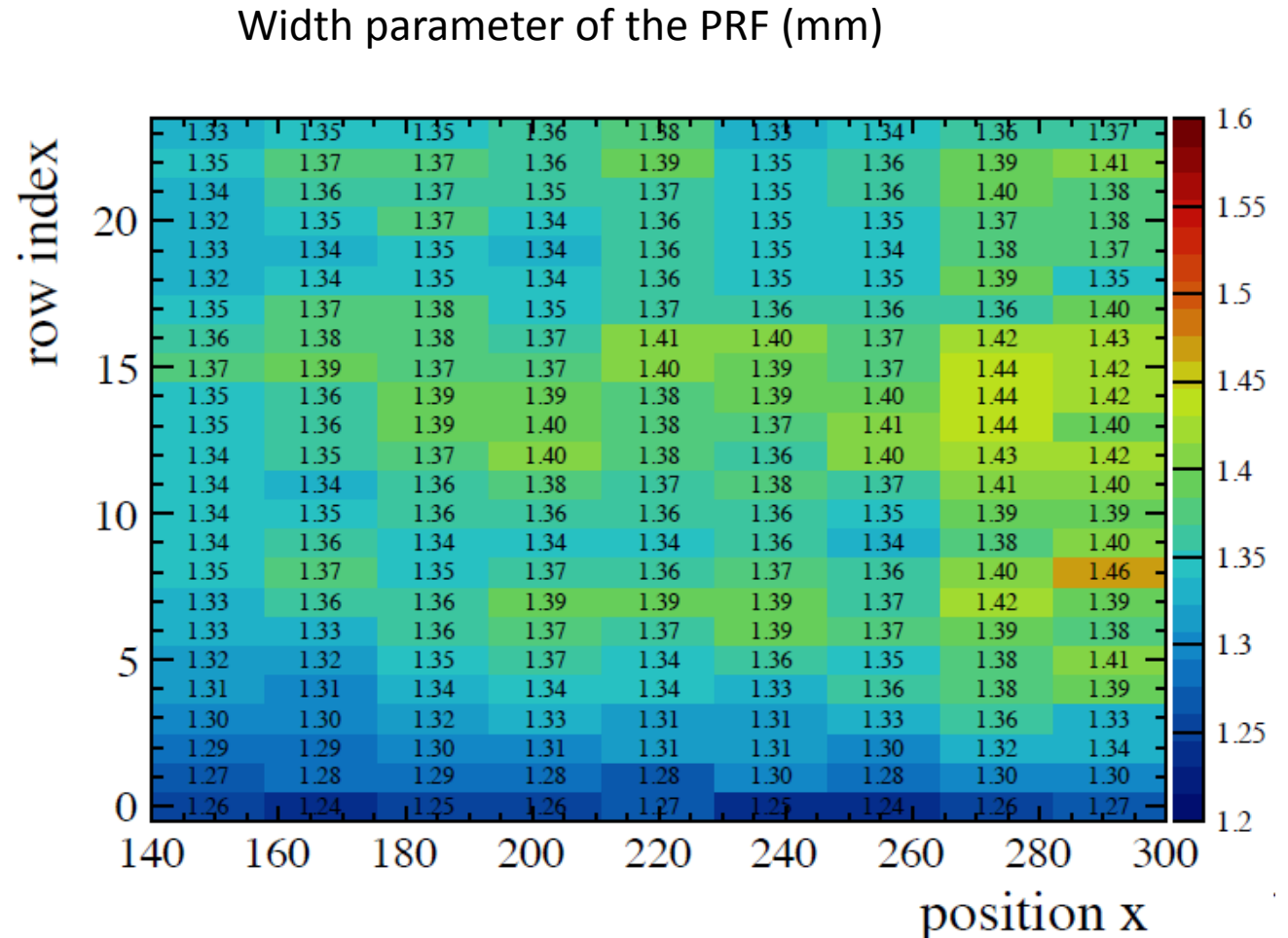


Take the geometrical mean between resolution including and excluding the hit in question to get an unbiased result



# Uniformity of the charge spreading

$$\sigma = \sqrt{2t/RC}$$

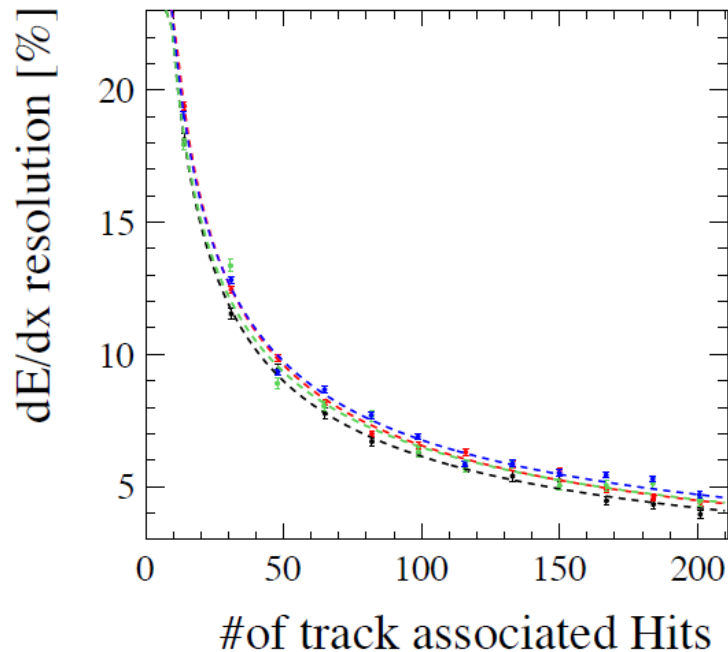


# Position resolution

Constant term  $\oplus$  sqrt(z) diffusion contribution

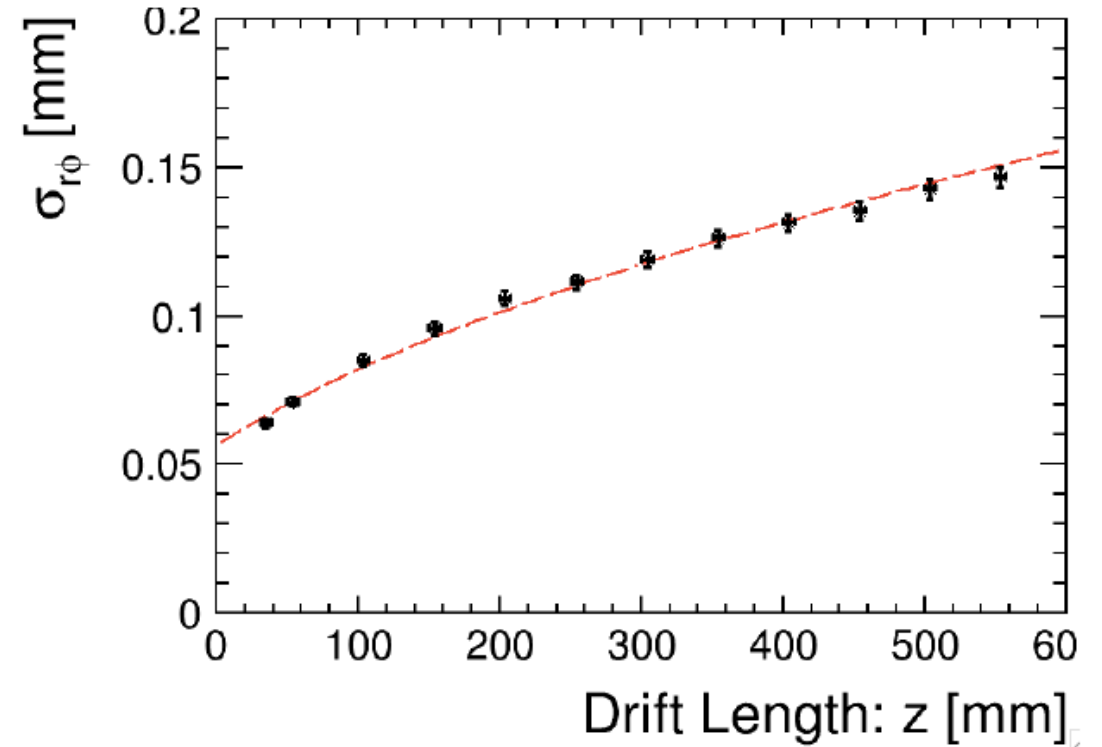
Constant term = 60  $\mu\text{m}$  with 3mm pads!  
(1/50th pad width)

# dE/dx resolution



4.8% resolution for  
nominal track length  
(192 hits)

average of 24 Rows

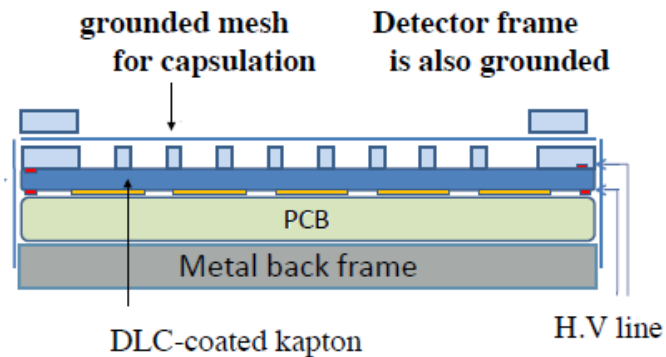


**Conclusion : Beam test shows that the high performances are preserved in the new scheme**

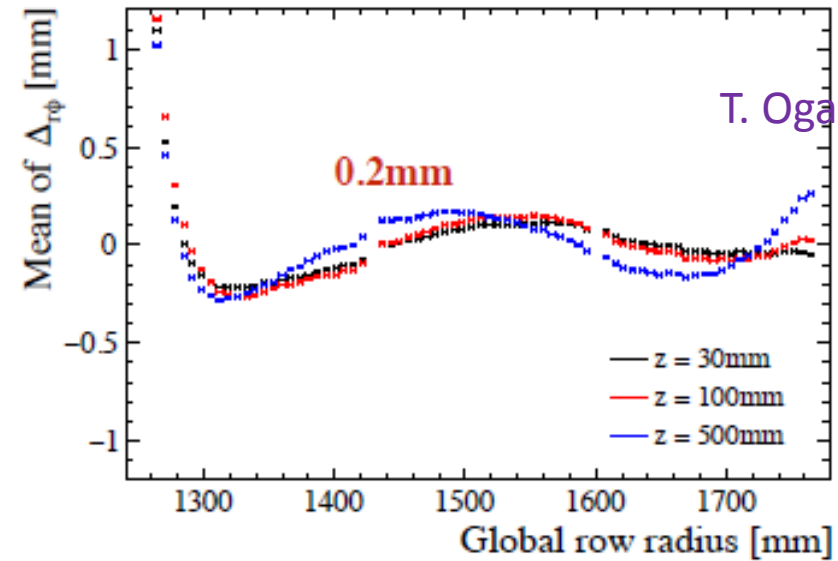
# Mitigation of the distortions at module edges

By grounding the mesh and encapsulating the anode at a positive potential, the amplification plane is an almost perfect equipotential, which allows the E-field to be very uniform, even close to the module boundary.

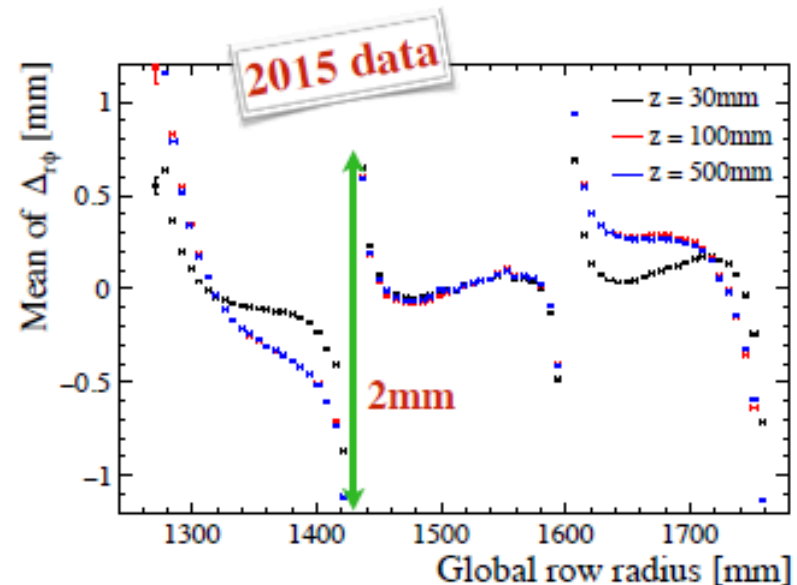
A reduction by an order of magnitude of the ExB distortions is observed.



track distortion in  $r\phi$

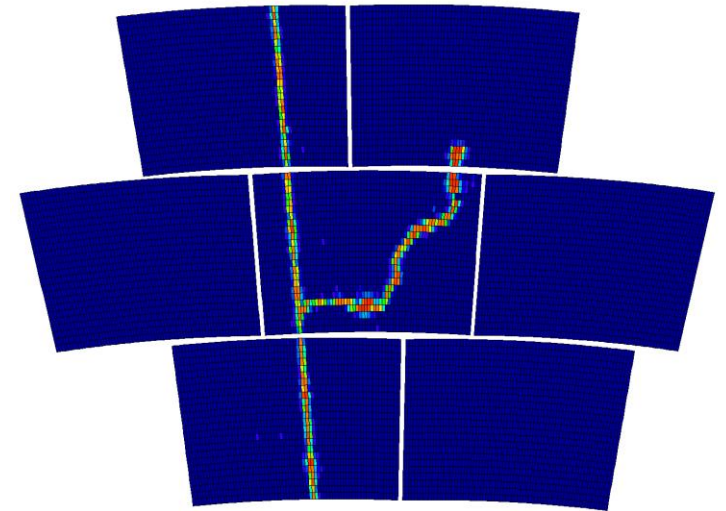
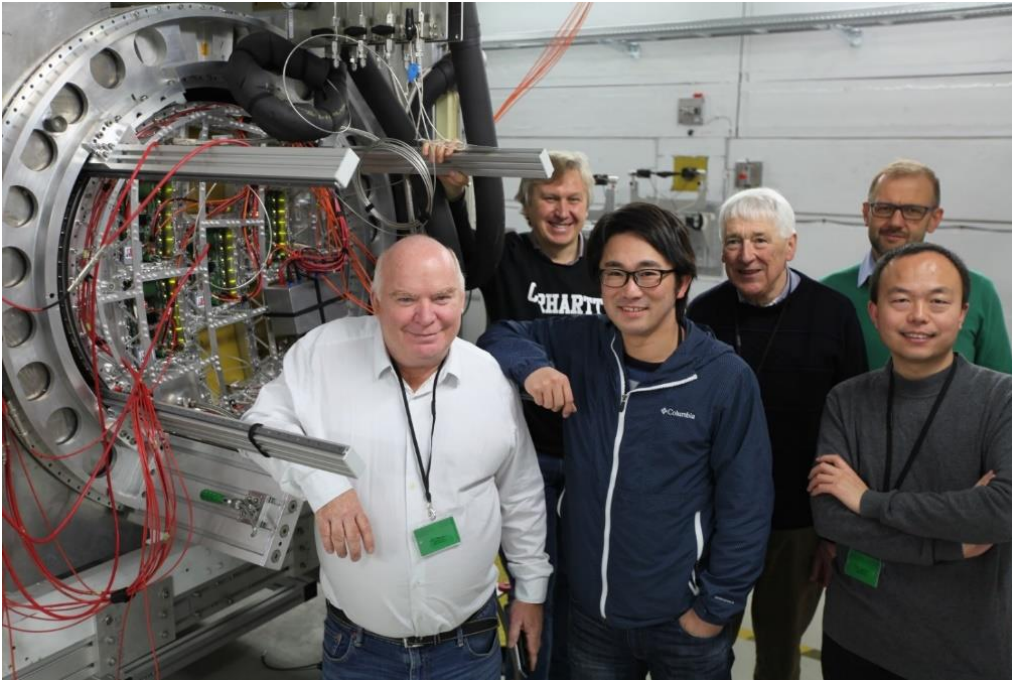


T. Ogawa, S. Ganjour



# Conclusion

The new scheme of **encapsulated resistive anode** Micromegas gives very satisfactory results (stable operation, suppressed distortions, increased flexibility)



Thanks to my colleagues D. Attié, S. Ganjour, T. Ogawa, M. Riallot, X. Coppolani, S. Emery, Huirong Qi, J.Timmermans, M. Titov, R. Diener, V. Prah and O.Schäfer